

# LTVS23H24LT1G

## S-LTVS23H24LT1G

### ESD Protection Diode

#### 1. FEATURES

- 300 watts peak pulse power.
- Low clamping voltage.
- Complies with IEC 61000-4-2 standards: Air discharge:  $\pm 30\text{kV}$   
Contact discharge:  $\pm 30\text{kV}$
- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

#### 2. APPLICATIONS

- Cellular Handsets and Accessories
- Portable Electronics
- Industrial Controls
- Set-Top Box
- Servers, Notebook, and Desktop PC

#### 3. DEVICE MARKING AND ORDERING INFORMATION

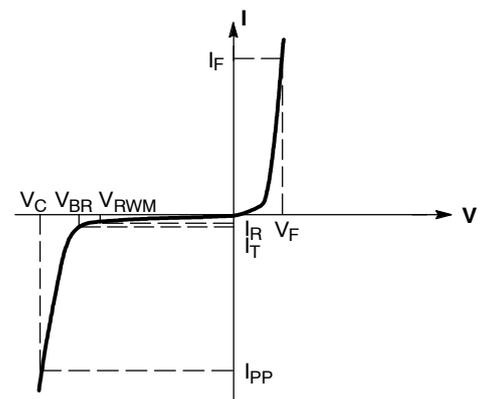
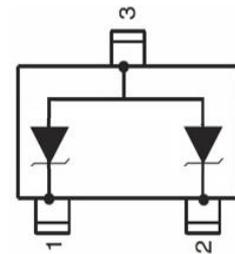
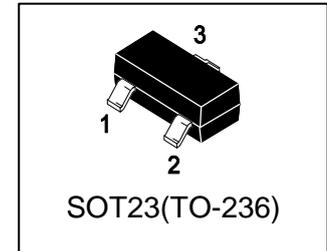
Device	Marking	Shipping
LTVS23H24LT1G	24P	3000/Tape&Reel

#### 4. MAXIMUM RATINGS(Ta = 25°C)

Parameter	Symbol	Limits	Unit
IEC 61000-4-2 (ESD) Contact		$\pm 30$	kV
Air		$\pm 30$	
peak pulse power@8/20 $\mu\text{s}$	PPP	300	W
peak pulse current @8/20 $\mu\text{s}$	IPP	8	A
Storage Temperature Range	Tstg	-55 ~ +150	°C
Operating Temperature Range	TJ	-55 ~ +125	°C

#### 5. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

Symbol	Parameter
IPP	Maximum Reverse Peak Pulse Current
VC	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
IR	Maximum Reverse Leakage Current @ VRWM
VBR	Breakdown Voltage @ IT
IT	Test Current
IF	Forward Current
VF	Forward Voltage @ IF
Ppk	Peak Power Dissipation
C	Capacitance @ VR = 0 and f = 1.0 MHz



Uni-Directional TVS

**6. ELECTRICAL CHARACTERISTICS (Ta= 25°C)**

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Reverse stand-off voltage	VRWM	-	-	24	V
Reverse leakage current (VRWM = 24 V, Ta= 25 °C)	IR	-	-	1	μA
Reverse breakdown voltage (IT = 1 mA)	VBR	25.6	-	-	V
Clamping Voltage (IPP = 1A (8 x 20μs pulse) (IPP = 5A (8 x 20μs pulse)	VC	-	-	30 36	V
Junction Capacitance (VR = 0V, f = 1MHz, Pin 1 to Pin2) (VR = 0V, f = 1MHz, Pin 1 to 3 and Pin 2 to3 )	CJ	-	-	30 60	pF

## 7. ELECTRICAL CHARACTERISTIC CURVES

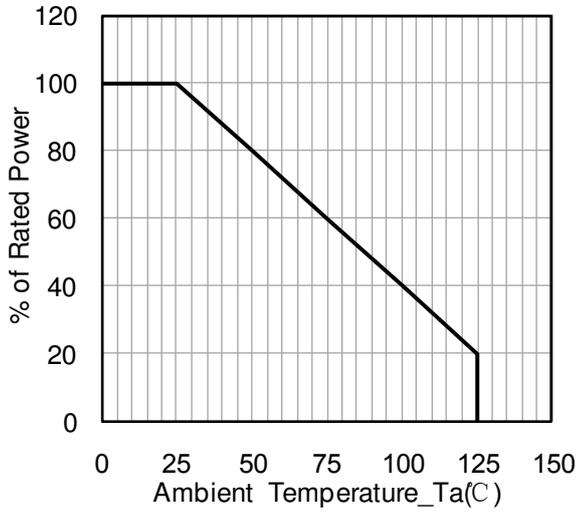


Figure 1. Power Derating Curve

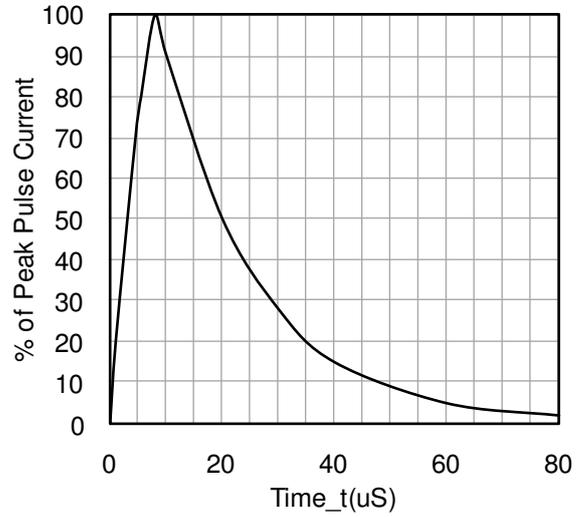


Figure 2. 8 X 20uS Pulse Waveform

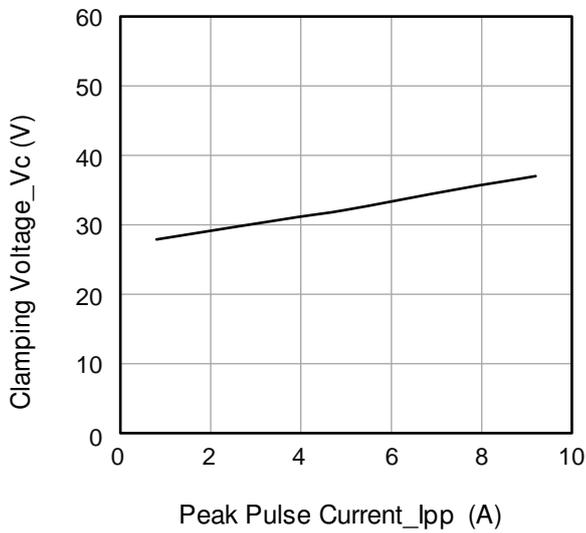


Figure 3. Clamping Voltage vs. Peak Pulse Current

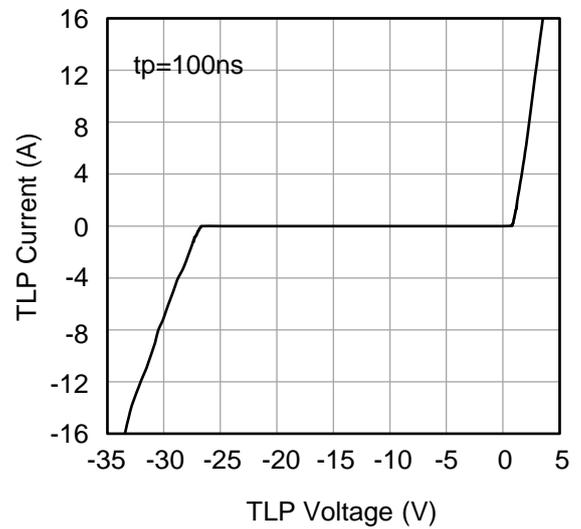
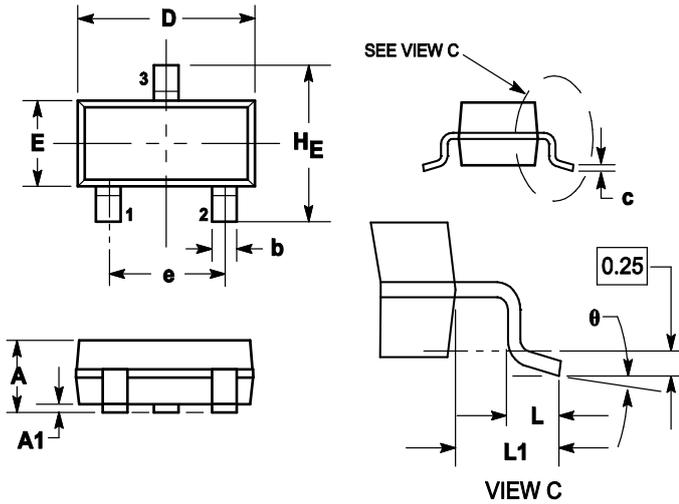


Figure 4. TLP Measurement

### 8.OUTLINE AND DIMENSIONS

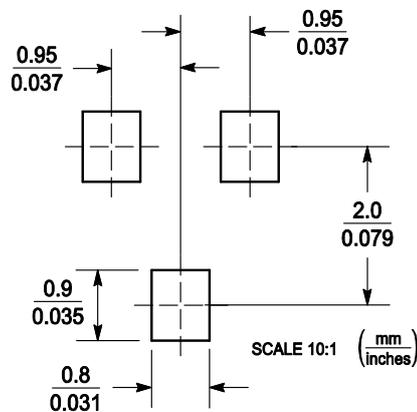
Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1	1.11	0.035	0.04	0.044
A1	0.01	0.06	0.1	0.001	0.002	0.004
b	0.37	0.44	0.5	0.015	0.018	0.02
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.9	3.04	0.11	0.114	0.12
E	1.20	1.3	1.4	0.047	0.051	0.055
e	1.78	1.9	2.04	0.07	0.075	0.081
L	0.10	0.2	0.3	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.4	2.64	0.083	0.094	0.104
θ	0°	---	10°	0°	---	10°

### 9.SOLDERING FOOTPRINT



## **DISCLAIMER**

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